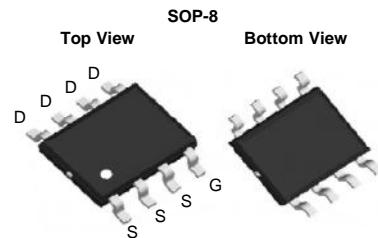


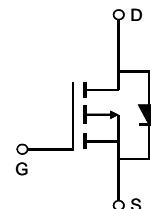
## Features

- -20V, -11A
- $R_{DS(ON)} < 14m\Omega$  @  $V_{GS} = -4.5V$
- $R_{DS(ON)} < 21m\Omega$  @  $V_{GS} = -2.5V$
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free



## Applications

- Load Switch
- PWM Application
- Power Management



## Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise specified)

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		-20	V
$V_{GSS}$	Gate-Source Voltage		$\pm 12$	V
$I_D$	Continuous Drain Current	$T_A = 25^\circ C$	-11	A
		$T_A = 100^\circ C$	-7	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>		-44	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>note2</sup>		64	mJ
$P_D$	Power Dissipation	$T_A = 25^\circ C$	3.1	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		40	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	$^\circ C$

## Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_D = -250\mu\text{A}$	-20	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}= -30\text{V}, V_{\text{GS}}=0\text{V},$	-	-	-1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}= \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_D = -250\mu\text{A}$		-0.5		V
$R_{\text{DS}(\text{on})}$ note3	Static Drain-Source on-Resistance	$V_{\text{GS}}= -10\text{V}, I_D = -10\text{A}$	-	13	14	$\text{m}\Omega$
		$V_{\text{GS}}= -4.5\text{V}, I_D = -5\text{A}$	-	17	21	
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}= -15\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$	-	1631	-	pF
$C_{\text{oss}}$	Output Capacitance		-	194	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	172	-	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}= -15\text{V}, I_D = -5\text{A}, V_{\text{GS}}= -10\text{V}$	-	30	-	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	5	-	nC
$Q_{\text{gd}}$	Gate-Drain("Miller") Charge		-	10	-	nC
<b>Switching Characteristics</b>						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DD}}= -15\text{V}, I_D = -10\text{A}, V_{\text{GS}}= -10\text{V}, R_{\text{GEN}}=2.4\Omega$	-	10	-	ns
$t_r$	Turn-on Rise Time		-	9.4	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	24	-	ns
$t_f$	Turn-off Fall Time		-	12	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current		-	-	-11	A
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-44	A
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_s = -11\text{A}$	-	-0.8	-1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}, V_{\text{DD}}= -15\text{V}, V_G= -10\text{V}, R_G=25\Omega, L=0.5\text{mH}, I_{\text{AS}}= -16\text{A}$

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%